

10/066023  
10/066023

01/30/02

U.S. UTILITY Patent Application

PATENT NUMBER and  
ISSUE DATE

APPL NUM 10066023 FILING DATE 01/30/2002 CLASS 757 SUBCLASS 72 GAU 26 28 EXAMINER Williams

\*\*APPLICANTS: Lam Allen; Williams Richard; Choi Alex;

\*\*CONTINUING DATA VERIFIED:

THIS APPLICATION IS A DIV OF 09/898,212 07/02/2001  
WHICH IS A CON OF 09/322,124 05/27/1999 PAT 6,256,200

\*\* FOREIGN APPLICATIONS VERIFIED:

BEST AVAILABLE COPY

PG-PUB DO NOT PUBLISH

RESCIND

Foreign priority claimed ☐ yes ☒ no  
35 USC 119 conditions met ☐ yes ☒ no

Verified and Acknowledged Examiners's initials

ATTORNEY DOCKET NO

M-7577-2D US

TITLE : Symmetrical package for semiconductor die

U.S. DEPT. OF COMM./PAT & TM-PTO-436 (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner <i>Alexander Williams</i> Primary Examiner	CLAIMS ALLOWED		
ISSUE FEE			Total Claims 11	Print Claim for O.G. 1	
Amount Due	Date Paid		DRAWING		
		Primary Examiner	Sheets Drawn 60	Figs. Drawn 92	Print Figs. 60, 92
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner		
WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.					

FILED WITH:

☐ DISK (CRF)

☐ CD-ROM

(Attached in pocket on right inside flap)